

### **Overview**

KEMET's Ultra HiQ-CBR 0505 Series surface mount multilayer ceramic capacitors (MLCCs) in C0G dielectric feature a robust and exceptionally stable copper electrode dielectric system as well as a square case size that offers excellent low loss performance (ultra high Q). These devices provide extremely low ESR and high self-resonance characteristics, and are well-suited for higher power applications where minimal heating due to I<sup>2</sup>R losses are a factor. CBR Series capacitors exhibit no change in capacitance with respect to time and voltage, and boast a negligible change in capacitance with reference to ambient



temperature. Capacitance change is limited to  $\pm 30 \text{ ppm/°C}$  from  $-55^{\circ}$ C to  $+125^{\circ}$ C.

CBR Series devices are suitable for many circuit applications including RF power amplifiers, mixers, oscillators, low noise amplifiers, filter networks, antenna tuning, timing circuits, delay lines, and MRI imaging coils.

### **Benefits**

- · Ultra high Q and extremely low ESR
- 0505 Square case size for higher SRF versus standard EIA case sizes
- High thermal stability
- 1 MHz to 50 GHz frequency range
- Operating temperature range of -55°C to +125°C
- Base metal electrode (BME) dielectric system
- Pb-free and RoHS compliant
- DC voltage rating of 250 V
- · Capacitance offerings ranging from 0.4 pF up to 100 pF
- Available capacitance tolerances of  $\pm 0.05$  pF,  $\pm 0.1$  pF,  $\pm 0.25$  pF,  $\pm 0.5$  pF,  $\pm 1\%$ ,  $\pm 2\%$ , and  $\pm 5\%$

# **Ordering Information**



| CBR    | 05                    | С                        | 330  | F   | Α                         | G          | Α                    | С                  |  |
|--------|-----------------------|--------------------------|--|---|---------------------------|------------|----------------------|--------------------|--|
| Series | Case Size<br>(L"x W") | Specification/<br>Series | Capacitance<br>Code (pF)   | Capacitance<br>Tolerance  | Rated<br>Voltage<br>(VDC) | Dielectric | Termination<br>Style | Termination Finish | Packaging/<br>Grade<br>(C-Spec) <sup>1</sup> |
| CBR    | 05 = 0505             | C = Standard             | Two significant digits<br>and number of zeros<br>Use 9 for 1.0 – 9.9 pF<br>Use 8 for 0.1 – 0.99 pF<br>e.g., 2.2 pF = 229<br>e.g., 0.5 pF = 508 | $A = \pm 0.05 \text{ pF} \\ B = \pm 0.10 \text{ pF} \\ C = \pm 0.25 \text{ pF} \\ D = \pm 0.50 \text{ pF} \\ F = \pm 1\% \\ G = \pm 2\% \\ J = \pm 5\%$ | A = 250 V                 | G = COG    | A = N/A              | C = 100% Matte Sn  | Blank =<br>7" Reel<br>Unmarked               |

<sup>1</sup> When ordering CBR Series devices, a "suffix" or "C-Spec" is not required to indicate a 7" reel packaging option. CBR devices are only available and shipped on 7" reels (paper tape). Bulk bag and cassette packaging options are not available. Please contact KEMET if you have a specific, non-standard packaging requirement.



### Benefits cont.

- · No piezoelectric noise
- No capacitance change with respect to applied rated DC voltage
- Negligible capacitance change with respect to temperature
- No capacitance decay with time
- Non-polar device, minimizing installation concerns
- 100% pure matte tin-plated termination finish allowing for excellent solderability

### **Applications**

Typical applications include critical timing, tuning, bypass, coupling, feedback, filtering, impedance matching and DC blocking.

Field applications include wireless and cellular base stations, wireless LAN, subscriber-based wireless services, wireless broadcast equipment, satellite communications, RF power amplifier (PA) modules, filters, voltage-controlled oscillators (VCOs), PAs, matching networks, RF modules, satellite communications and medical electronics.

### Qualification

RF and microwave products are subject to internal qualification. Details regarding test methods and conditions are referenced in Table 4, Performance & Reliability.

### **Environmental Compliance**

Pb-free and RoHS compliant.



### **Dimensions – Millimeters (Inches)**





| Case<br>Size<br>(in.) | Case<br>Size<br>(mm) | L<br>Length                            | W<br>Width                 | T<br>Thickness             | B<br>Bandwidth                        | Mounting<br>Technique |
|-----------------------|----------------------|--|----------------------------|----------------------------|---------------------------------------|-----------------------|
| 0505                  | 1414                 | 1.40+0.38/-0.25<br>(0.055+0.015/-0.01) | 1.40±0.38<br>(0.055±0.015) | 1.15±0.15<br>(0.045±0.006) | 0.25+0.25-0.13<br>(0.010+0.010-0.005) | Solder Reflow Only    |

### **Electrical Parameters/Characteristics**

| Item   | Parameters/Characteristics   |
|--|--|
| Operating Temperature Range:   | -55°C to +125°C  |
| Capacitance Change with Reference to<br>+25°C and 0 VDC Applied (TCC): | 0 ±30 ppm/°C   |
| Aging Rate (Maximum % Capacitance Loss/Decade Hour):                   | 0%   |
| <sup>1</sup> Dielectric Withstanding Voltage (DWV):                    | See Dielectric Withstanding Voltage Table<br>(5±1 seconds and charge/discharge not exceeding 50 mA)          |
| <sup>2</sup> Quality Factor (Q):                                       | ≥ 1,400 for capacitance values ≥30 pF<br>≥ 800 + 20°C for capacitance values < 30 pF (C = Capacitance in pF) |
| <sup>3</sup> Insulation Resistance (IR) Limit at 25°C:                 | 10 G $\Omega$ minimum (rated voltage applied for 120±5 seconds)  |

<sup>1</sup>DWV is the voltage a capacitor can withstand (survive) for a short period of time. It exceeds the nominal and continuous working voltage of the capacitor.

 $^{2}$  Capacitance and quality factor (Q) measured at 1 MHz ±100 kHz and 1.0 ±0.2 Vrms.

<sup>3</sup> To obtain IR limit, divide  $M\Omega$ - $\mu$ F value by the capacitance and compare to G $\Omega$  limit. Select the lower of the two limits.

Note: When measuring capacitance it is important to ensure the set voltage level is held constant. The HP4284 and Agilent E4980 have a feature known as Automatic Level Control (ALC). The ALC feature should be switched to "ON."



### **Dielectric Withstanding Voltage Table**

| Rated Voltage (VDC) | 250 V |
|---------------------|-------|
| DWV                 | 200%  |

## **Electrical Characteristics**





### ESR vs. Frequency 0505



### Q vs. Frequency 0505





## Table 1 – CBR Series, Capacitance Range Waterfall

| Case Size -      | Inches (mm)                | 0505 (1414)                                  |
|------------------|----------------------------|--|
| Length           | mm<br>(Inches)             | 1.40 +0.38 / -0.25<br>(0.055 +0.015 / -0.01) |
| Width            | mm                         | 1.40 ± 0.38                                  |
| Width            | (Inches)                   | (0.055 ± 0.015)                              |
| Thickness        | mm<br>(Inches)             | 1.15 ± 0.15<br>(0.045 ± 0.006)               |
| Bandwidth        | mm                         | 0.25 + 0.25 - 0.13                           |
|                  | (Inches)                   | (0.010 + 0.010 - 0.005)                      |
|                  | e Code                     | 250<br>A                                     |
| voitag           |                            |  |
| Capacitance      | Capacitance<br>Tolerance   | Capacitance Code<br>(Available Capacitance)  |
| 0.4 pF           |                            | 408  |
| 0.5 pF           | -                          | 508  |
| 0.6 pF           | -                          | 608  |
| 0.7 pF<br>0.8 pF |                            | 708  |
| 0.9 pF           |                            | 908  |
| 1.0 pF           |                            | 109  |
| 1.1 pF           |                            | 119  |
| 1.2 pF           |                            | 129  |
| 1.3 pF           |                            | 139  |
| 1.4 pF           | -                          | 149  |
| 1.5 pF<br>1.6 pF | -                          | 159  |
| 1.7 pF           |                            | 179  |
| 1.8 pF           |                            | 189  |
| 1.9 pF           |                            | 199  |
| 2.0 pF           |                            | 209  |
| 2.1 pF           | -                          | 219  |
| 2.2 pF           | -                          | 229  |
| 2.3 pF<br>2.4 pF | -                          | 239 249                                      |
| 2.4 pr<br>2.5 pF | -                          | 259  |
| 2.6 pF           | A = ±0.05pF                | 269  |
| 2.7 pF           | $B = \pm 0.10 pF$          | 279  |
| 2.8 pF           | C = ±0.25pF<br>D = ±0.50pF | 289  |
| 2.9 pF           | D 10.00pi                  | 299  |
| 3.0 pF           |                            | 309  |
| 3.1 pF           | -                          | 319<br>329                                   |
| 3.2 pF<br>3.3 pF | -                          | 329  |
| 3.4 pF           | -                          | 349  |
| 3.5 pF           |                            | 359  |
| 3.6 pF           |                            | 369  |
| 3.7 pF           | -                          | 379  |
| 3.8 pF           | -                          | 389  |
| 3.9 pF<br>4.0 pF | -                          | <u> </u>                                     |
| 4.0 pr           |                            | 419  |
| 4.2 pF           |                            | 429  |
| 4.3 pF           |                            | 439  |
| 4.4 pF           |                            | 449  |
| 4.5 pF           |                            | 459  |
| 4.6 pF<br>4.7 pF |                            | 469 479                                      |
| 4.7 pF<br>4.8 pF |                            | 479  |
| 4.9 pF           |                            | 499  |
| 5.0 pF           |                            | 509  |
| Rated Vol        | tage (VDC)                 | 250  |
|                  | e Code                     | A  |

\* Available only in "B" (±0.1 pF) capacitance tolerance.



# Table 1 – CBR Series, Capacitance Range Waterfall cont'd

| Case Size -      | Inches (mm)              | 0505 (1414)                                   |
|------------------|--------------------------|---|
| Length           | mm<br>(Inches)           | 1.40 +0.38 / -0.25<br>(0.055 +0.015 / -0.01)  |
| Width            | mm                       | 1.40 ± 0.38                                   |
|                  | (Inches)<br>mm           | (0.055 ± 0.015)<br>1.15 ± 0.15                |
| Thickness        | (Inches)                 | (0.045 ± 0.006)                               |
| Bandwidth        | mm<br>(Inches)           | 0.25 + 0.25 - 0.13<br>(0.010 + 0.010 - 0.005) |
| Rated Vol        | tage (VDC)               | 250   |
|                  | ge Code                  | A   |
| Capacitance      | Capacitance<br>Tolerance | Capacitance Code<br>(Available Capacitance)   |
| 5.1 pF           | _                        | 519   |
| 5.2 pF           |                          | 529   |
| 5.3 pF           | _                        | 539   |
| 5.4 pF           | -                        | 549   |
| 5.5 pF           | _                        | 559   |
| 5.6 pF           | _                        | 569   |
| 5.7 pF<br>5.8 pF | _                        | 589   |
| 5.9 pF           | _                        | 599   |
| 6.0 pF           | _                        | 609   |
| 6.1 pF           | _                        | 619   |
| 6.2 pF           | -                        | 629   |
| 6.3 pF           | -                        | 639   |
| 6.4 pF           | -                        | 649   |
| 6.5 pF           | -                        | 659   |
| 6.6 pF           |                          | 669   |
| 6.7 pF           |                          | 679   |
| 6.8 pF           |                          | 689   |
| 6.9 pF           |                          | 699   |
| 7.0 pF           |                          | 709   |
| 7.1 pF           |                          | 719   |
| 7.2 pF           | B = ±0.10pF              | 729   |
| 7.3 pF           | $C = \pm 0.25 pF$        | 739   |
| 7.4 pF           | D = ±0.50pF              | 749   |
| 7.5 pF           | _                        | 759   |
| 7.6 pF           | _                        | 769   |
| 7.7 pF           |                          | 779   |
| 7.8 pF           |                          | 789   |
| 7.9 pF           | _                        | 799   |
| 8.0 pF           | _                        | 809   |
| 8.1 pF           | -                        | 819   |
| 8.2 pF<br>8.3 pF |                          | 839   |
| 8.4 pF           | -                        | 849   |
| 8.5 pF           | -                        | 859   |
| 8.6 pF           |                          | 869   |
| 8.7 pF           | _                        | 879   |
| 8.8 pF           |                          | 889   |
| 8.9 pF           |                          | 899   |
| 9.0 pF           |                          | 909   |
| 9.1 pF           |                          | 919   |
| 9.2 pF           |                          | 929   |
| 9.3 pF           |                          | 939   |
| 9.4 pF           |                          | 949   |
| 9.5 pF           |                          | 959   |
| Rated Vo         | tage (VDC)               | 250   |
| Volta            | ge Code                  | Α   |



# Table 1 – CBR Series, Capacitance Range Waterfall cont'd

| Case Size -    | Case Size – Inches (mm)  |   |  |  |  |  |  |
|----------------|--------------------------|---|--|--|--|--|--|
| Length         | mm<br>(Inches)           | 1.40 +0.38 / -0.25                          |  |  |  |  |  |
|                | mm                       | (0.055 +0.015 / -0.01)<br>1.40 ± 0.38       |  |  |  |  |  |
| Width          | (Inches)                 | (0.055 ± 0.015)                             |  |  |  |  |  |
| Thielenaaa     | mm                       | 1.15 ± 0.15                                 |  |  |  |  |  |
| Thickness      | (Inches)                 | (0.045 ± 0.006)                             |  |  |  |  |  |
| Bandwidth      | mm                       | 0.25 + 0.25 - 0.13                          |  |  |  |  |  |
|                | (Inches)                 | (0.010 + 0.010 - 0.005)                     |  |  |  |  |  |
| Rated Vol      | tage (VDC)               | 250   |  |  |  |  |  |
| Voltag         | e Code                   | A   |  |  |  |  |  |
| Capacitance    | Capacitance<br>Tolerance | Capacitance Code<br>(Available Capacitance) |  |  |  |  |  |
| 9.6 pF         |                          | 969   |  |  |  |  |  |
| 9.7 pF         | -                        | 979   |  |  |  |  |  |
| 9.8 pF         |                          | 989   |  |  |  |  |  |
| 9.9 pF         | -                        | 999   |  |  |  |  |  |
| 10 pF          |                          | 100   |  |  |  |  |  |
| 11 pF          | -                        | 110   |  |  |  |  |  |
| 12 pF<br>13 pF | -                        | 120   |  |  |  |  |  |
| 15 pF          |                          | 150   |  |  |  |  |  |
| 16 pF          | -                        | 160   |  |  |  |  |  |
| 18 pF          |                          | 180   |  |  |  |  |  |
| 20 pF          |                          | 200   |  |  |  |  |  |
| 22 pF          |                          | 220   |  |  |  |  |  |
| 24 pF          | F = ±1%                  | 240   |  |  |  |  |  |
| 27 pF          | G = ±2%                  | 270   |  |  |  |  |  |
| 30 pF          | J = ±5%                  | 300   |  |  |  |  |  |
| 33 pF          |                          | 330   |  |  |  |  |  |
| 36 pF          |                          | 360   |  |  |  |  |  |
| 39 pF          | -                        | 390   |  |  |  |  |  |
| 43 pF          |                          | 430   |  |  |  |  |  |
| 47 pF          | -                        | 470   |  |  |  |  |  |
| 51 pF          |                          | 510   |  |  |  |  |  |
| 56 pF          |                          | 560   |  |  |  |  |  |
| 62 pF          |                          | 620   |  |  |  |  |  |
| 68 pF<br>75 pF | -                        | 750   |  |  |  |  |  |
| 82 pF          |                          | 820   |  |  |  |  |  |
| 91 pF          |                          | 910   |  |  |  |  |  |
| 100 pF         |                          | 101   |  |  |  |  |  |
|                | tage (VDC)               | 250   |  |  |  |  |  |
|                | le Code                  | A   |  |  |  |  |  |
| voitag         |                          |   |  |  |  |  |  |



### Table 2 – Chip Thickness/Reeling Quantities

| Chip Size   | <b>Chip Thickness</b> | Reel Quantity |                                    |  |  |
|-------------|-----------------------|---------------|------------------------------------|--|--|
| Inches (mm) | (mm)                  | 7" Paper      | 13" Paper                          |  |  |
| 0505 (1414) | 1.15 ±0.15            | 3,000         | Contact KEMET<br>for availability. |  |  |

## Table 3 – Chip Capacitor Land Pattern Design Recommendations per IPC-7351 (mm)

| Case<br>Size<br>(Inches) | Case<br>Size<br>(mm) | N    | /laximu | sity Lev<br>ım (Mo<br>rotrusio | st) Lan | d    | Density Level B:<br>Median (Nominal) Land<br>Protrusion |      |      | Density Level C:<br>Minimum (Least) Land<br>Protrusion |      |      |      |      |      |      |
|--------------------------|----------------------|------|---------|--------------------------------|---------|------|---|------|------|--|------|------|------|------|------|------|
| (moneo)                  | ()                   | C    | Y       | X                              | V1      | V2   | C   | Y    | X    | V1   | V2   | C    | Y    | X    | V1   | V2   |
| 0505                     | 1414                 | 0.92 | 1.15    | 1.89                           | 3.99    | 2.89 | 0.82  | 0.95 | 1.79 | 3.09   | 2.29 | 0.72 | 0.75 | 1.69 | 2.43 | 1.93 |

**Density Level A:** For low-density product applications. Recommended for wave solder applications and provides a wider process window for reflow solder processes. KEMET only recommends wave soldering of 0603(1608) and 0805 (2012) case sizes.

**Density Level B:** For products with a moderate level of component density. Provides a robust solder attachment condition for reflow solder processes. **Density Level C:** For high component density product applications. Before adapting the minimum land pattern variations the user should perform qualification testing based on the conditions outlined in IPC Standard 7351 (IPC-7351).

Image below based on Density Level B for an EIA 1608 case size.





### **Soldering Process**

#### **Recommended Soldering Technique:**

• 0505 case sizes are limited to solder reflow only

#### **Recommended Soldering Profile:**

• KEMET recommends following the guidelines outlined in IPC/JEDEC J-STD-020

#### **Recommended Solder Alloys:**

| Alloy   | Composition              | Solidus | Liquidous |
|---------|--------------------------|---------|-----------|
| In50    | 50 ln, 50 Pb             | 180°C   | 209°C     |
| In52    | 52 In, 48 Sn             | 118°C   | 118°C     |
| Sn62    | 62.5 Sn, 36.1 Pb, 1.4 Ag | 179°C   | 179°C     |
| Sn63    | 63 Sn, 37 Pb             | 183°C   | 183°C     |
| Pb-free | 95.5 Sn, 3.8 Ag, 0.7 Cu  | 217°C   | 217°C     |
| Hi-Temp | 5 Sn, 93.5 Pb, 1.5 Ag    | 296°C   | 301°C     |
| Sn5     | 5 Sn, 95 Pb              | 308°C   | 312°C     |



# Table 4 - Performance & Reliability: Test Methods & Conditions

| Stress                          |  | Test or Inspection M   | ethod                                  | Requirements  |
|---------------------------------|--|--|--|---|
| Terminal Strength               | 05   | zing force:<br>05 case sizes: 5N<br>e: 10±1 second   |  | No visible damage or separation of termination system.  |
| Vibration<br>Resistance         | Total am<br>Test time                        | n frequency: 10 ~ 55 Hz/mini<br>iplitude: 1.5 mm<br>e: 6 hours (Two hours each ir<br>icular directions.)   |  | No visible damage.<br>Capacitance change and Q/DF: To meet initial specification  |
| Solderability                   |  | emperature: 235±5°C<br>time: 2±0.5 seconds   |  | 95% minimum coverage of termination finish.   |
| Board Flex                      | means o<br>deflectio<br>5±1 seco<br>Store at | or is mounted to a substrate of<br>f ram at a rate of 1 mm per s<br>on becomes 1 mm. (Deflectio<br>ond)<br>room temperature for 24±2 h<br>ng electrical properties.  | econd until the<br>n is maintained for | No visible damage.<br>Capacitance change: within ±5.0% or ±0.5 pF, whichever<br>is larger.<br>(Capacitance change is monitored during flexure.)   |
| Resistance to<br>Soldering Heat | Dipping<br>Preheati<br>the capa<br>Store at  | emperature: 260±5°C<br>time: 10±1 second<br>ng: 120 to 150°C for 1 minute<br>citor in a eutectic solder.<br>room temperature for 24±2 h<br>ng electrical properties. |  | No visible damage.<br>Capacitance change: within ±2.5% or ±0.25 pF, whichever<br>is larger.<br>Q/DF, IR and dielectric strength: To meet initial<br>requirements.<br>25% maximum leaching on each edge. |
|                                 | 5 cycles                                     | of steps 1 – 4:  |  |   |
|                                 | Step   | Temperature (°C)   | Time (minutes)                         |   |
| -                               | 1  | Minimum operating temperatue +0/-3   | 30±3                                   | No visible damage.<br>Capacitance change: within ±2.5% or ±0.25 pF, whichever   |
| Temperature<br>Cycling          | 2  | Room temperature   | 2 ~ 3                                  | is larger.  |
| - , - 3                         | 3  | Maximum operating temperature +3/-0  | 30±3                                   | Q/DF, IR and dielectric strength: To meet initial requirements.   |
|                                 | 4  | Room temperature (25°C)  | 2 ~ 3                                  |   |
|                                 |  | room temperature for 24±2 h<br>ng electrical properties.   | ours before                            |   |



# Table 4 - Performance & Reliability: Test Methods & Conditions cont.

| Stress                               | Test or Inspection Method  | Requirements  |
|--------------------------------------|--|---|
| Humidity (Damp Heat)<br>Steady State | Test temperature: 40±2°C<br>Humidity: 90 ~ 95% RH<br>Test time: 500 +24/-0 hours<br>Store at room temperature for 24±2 hours before<br>measuring electrical properties.  | No visible damage.<br>Capacitance change: within ±5.0% or ±0.5 pF, whichever<br>is larger.<br>Q/DF value: Capacitance ≥ 30 pF, Q ≥ 350,<br>10 pF ≤ Capacitance < 30 pF, Q ≥ 275 +2.5°C<br>Capacitance < 10 pF; Q ≥ 200 +10°C<br>IR: ≥ 1GΩ |
| Humidity (Damp Heat)<br>Load         | Test temperature: 40±2°C<br>Humidity: 90 ~ 95% RH<br>Test time: 500 +24/-0 hours<br>Applied voltage: rated voltage<br>Store at room temperature for 24±2 hours before<br>measuring electrical properties.          | No visible damage.<br>Capacitance change: within ±7.5% or ±0.75 pF, whichever<br>is larger.<br>Q/DF value: Capacitance ≥ 30 pF, Q ≥ 200,<br>Capacitance < 30 pF, Q ≥ 100+10/3°C<br>IR: ≥ 500MΩ  |
| High Temperature Life                | Test temperature: 125±3°C<br>Applied voltage:<br>200% of rated voltage (6.3 VDC – 250 VDC)<br>Test time: 1,000 +24/-0 hours<br>Store at room temperature for 24±2 hours before<br>measuring electrical properties. | No visible damage.<br>Capacitance change: within ±3.0% or ±0.3 pF, whichever<br>is larger.<br>Q/DF value: Capacitance ≥ 30 pF, Q ≥350,<br>10 pF ≤ Capacitance < 30 pF, Q ≥ 275 +2.5°C<br>Capacitance <10 pF, Q ≥ 200 +10°C<br>IR: ≥1 GΩ   |
| ESR                                  | The ESR should be measured at room temperature and tested at frequency $1\pm0.1$ GHz.  | 0505 Case Size           0.4pF ≤Capacitance <1.0pF: < 1500mΩ  |



### **Storage and Handling**

Ceramic chip capacitors should be stored in normal working environments. While the chips themselves are quite robust in other environments, solderability will be degraded by exposure to high temperatures, high humidity, corrosive atmospheres, and long term storage. In addition, packaging materials will be degraded by high temperature –reels may soften or warp, and tape peel force may increase. KEMET recommends that maximum storage temperature not exceed 40°C, and maximum storage humidity not exceed 70% relative humidity. In addition, temperature fluctuations should be minimized to avoid condensation on the parts, and atmospheres should be free of chlorine and sulfur bearing compounds. For optimized solderability, chip stock should be used promptly, preferably within 1.5 years of receipt.

### Construction



### Marking

Hi CBR series devices are supplied unmarked. If you require marked product, please contact KEMET for availablility of a laser-marked option.



### **Tape & Reel Packaging Information**

KEMET offers RF and Microwave Multilayer Ceramic Chip Capacitors packaged in 8 mm tape on 7" reels. This packaging system is compatible with all tape-fed automatic pick and place systems.



## Table 5 – Carrier Tape Configuration (mm)

| EIA Case Size | Tape Size (W)* | Pitch (P <sub>1</sub> )* |  |
|---------------|----------------|--------------------------|--|
| 0505          | 8              | 4                        |  |

\*Refer to Figure 1 & 2 for W and P1 carrier tape reference locations. \*Refer to Table 6 for tolerance specifications.



## Figure 1 – Punched (Paper) Carrier Tape Dimensions



## Table 6 – Punched (Paper) Carrier Tape Dimensions

Metric will govern

| Constant Dimensions – Millimeters (Inches) |  |                                   |                                    |                           |                          |                           |                       |  |                              |
|--|--|-----------------------------------|------------------------------------|---------------------------|--------------------------|---------------------------|-----------------------|--|------------------------------|
| Tape Size                                  | Do   |                                   | E                                  | P <sub>0</sub>            | P <sub>2</sub>           | R Refer                   | ence Note 1           |  | K <sub>0</sub>               |
| 8 mm                                       | 1.55+<br>(0.061+(                          |                                   | .75±0.10<br>)69±0.004)             | 4.0±0.10<br>(0.157±0.004) | 2.0±0.0<br>(0.079±0.0    |                           | 25.0<br>.984)         |  | Aaximum 1.5<br>aximum 0.060) |
|  | Variable Dimensions – Millimeters (Inches) |                                   |                                    |                           |                          |                           |                       |  |                              |
| Tape Size                                  | Pitch                                      | A <sub>0</sub>                    | B <sub>0</sub>                     | F                         | P <sub>1</sub>           | Т                         | W                     |  | D <sub>1</sub>               |
| 8 mm                                       | Single<br>(4 mm)                           | Maximum 1.9<br>(Maximum<br>0.075) | Maximum 1.90<br>(Maximum<br>0.075) | 3.5±0.05<br>(0.138±0.002) | 4.0±0.1<br>(0.157±0.004) | 0.23±0.1<br>(0.009±0.004) | 8.0±0.2<br>(0.315±0.0 |  | 1.00±0.1<br>(0.039±0.004)    |

1. The tape with or without components shall pass around R without damage (see Figure 3).



### **Packaging Information Performance Notes**

- 1. Cover Tape Break Force: 1.0 Kg minimum.
- 2. Cover Tape Peel Strength: The total peel strength of the cover tape from the carrier tape shall be:

| Tape Width   | Peel Strength                    |
|--------------|----------------------------------|
| 8 mm         | 0.1 to 1.0 newton (10 to 100 gf) |
| 12 and 16 mm | 0.1 to 1.3 newton (10 to 130 gf) |

The direction of the pull shall be opposite the direction of the carrier tape travel. The pull angle of the carrier tape shall be  $165^{\circ}$  to  $180^{\circ}$  from the plane of the carrier tape. During peeling, the carrier and/or cover tape shall be pulled at a velocity of  $300 \pm 10$  mm/minute.

**3. Labeling:** Bar code labeling (standard or custom) shall be on the side of the reel opposite the sprocket holes. *Refer to EIA Standards 556 and 624*.

### Figure 2 – Bending Radius



## Figure 3 – Tape Leader & Trailer Dimensions





### Figure 4 – Maximum Camber



# Figure 5 – Reel Dimensions



# Table 7 – Reel Dimensions

Metric will govern

| Constant Dimensions — Millimeters (Inches) |                                  |                                    |                           |  |  |  |
|--|----------------------------------|------------------------------------|---------------------------|--|--|--|
| Tape Size                                  | Reel Size                        | А                                  | С                         |  |  |  |
| 8 mm                                       | 7                                | 178±0.10<br>(7.008±0.004)          | 13.0±0.50<br>(0.512±0.02) |  |  |  |
| Variable Dimensions — Millimeters (Inches) |                                  |                                    |                           |  |  |  |
| Tape Size                                  | N Minimum<br>See Note 2, Table 6 |                                    |                           |  |  |  |
| 8 mm                                       | 60±1.0<br>(2.362±0.04)           | 8.4+1.5/-0.0<br>(0.331+0.059/-0.0) |                           |  |  |  |



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